



Product Change Notification

112930 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112930 - 00
Change Title: Intel® Centrino® Wireless-N 2230 SKUs:
2230BN.HMWG; 2230BN.HMWGBR;
2230BN.HMWWB
PCN 112930-00, Product Material, Label
PCB Material Change and Label Update
Date of Publication: March 06, 2014

Key Characteristics of the Change:

Product Material, Label

Forecasted Key Milestones:

| | |
|---|--------------|
| Date Customer Must be Ready to Receive Post-Conversion Material: | Apr 22, 2014 |
|---|--------------|

Description of Change to the Customer:

The Intel® Centrino® Wireless-N 2230 SKUs listed in this PCN will undergo the following changes:

1. The current printed circuit board FR4 material S1155 has been discontinued and will be replaced by S1150G. S1150G has passed UL certification and was determined to be equivalent to S1155. S1150G has been fully qualified and all 2014 released products were developed with S1150G. The only impact is a change to the UL Marking on some of the PCB suppliers.
2. The Intel Tracking Number on the product label for 2230BN.HMWG will change as follows:

| Product Code | Current | New |
|--------------|---------|-----|
| 2230BN.HMWG | 0D | 0E |

Customer Impact of Change and Recommended Action:

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

For your information only. No change to form fit or function. No change to Intel Ordering codes.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

| Product Code | MM# | Pre Change TA | Post Change TA |
|----------------|--------|---------------|----------------|
| 2230BN.HMW G | 917557 | G35006-009 | G35006-010 |
| 2230BN.HMW WB | 920118 | G54989-004 | G54989-005 |
| 2230BN.HMW GBR | 924061 | G73780-001 | G73780-002 |

PCN Revision History:

Date of Revision:

March 6, 2014

Revision Number:

00

Reason:

Originally Published PCN